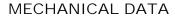
Taiwan Semiconductor

# 3A, 400V - 600V Super Fast Rectifiers

#### **FEATURES**

- High efficiency, Low VF
- High current capability
- High surge current capability
- Low power loss
- Compliant to RoHS Directive 2011/65/EU and in accordance to WEEE 2002/96/EC
- Halogen-free according to IEC 61249-2-21



**Case:** DO-204AC (DO-15)

Molding compound, UL flammability classification rating 94V-0 Packing code with suffix "G" means green compound (halogen-free)

Terminal: Pure tin plated leads, solderable per JESD22-B102

Meet JESD 201 class 1A whisker test

Weight: 1.2g (approximately)







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	J-/\I	

MAXIMUM RATINGS AND ELECTRICAL CHARAG	CTERISTICS	(T <sub>A</sub> =25°C unless othe	rwise noted)	
PARAMETER	SYMBOL	31DF4	31DF6	UNIT
Maximum repetitive peak reverse voltage	$V_{RRM}$	400	600	V
Maximum RMS voltage	$V_{RMS}$	280	420	V
Maximum DC blocking voltage	$V_{DC}$	400	600	V
Maximum average forward rectified current	I <sub>F(AV)</sub>	3		А
Peak forward surge current, 8.3 ms single half sine-wave superimposed on rated load	I <sub>FSM</sub>	45		А
Maximum instantaneous forward voltage (Note 1) @ 3 A	V <sub>F</sub>	1.7		V
Maximum reverse current @ rated $V_R$ $T_J$ =25°C $T_J$ =125°C	I <sub>R</sub>	20 100		μА
Maximum reverse recovery time (Note 2)	t <sub>rr</sub>	35		ns
Typical thermal resistance	$R_{\theta JA}$	80		°C/W
Operating junction temperature range	TJ	- 40 to +150		°C
Storage temperature range	T <sub>STG</sub>	- 40 to +150		°C

Note 1: Pulse test with PW=300  $\mu$ s, 1% duty cycle

Note 2: Reverse Recovery Test Conditions:  $I_F$ =0.5A,  $I_R$ =1.0A,  $I_{RR}$ =0.25A



ORDERING INFORMATION				
PART NO.	PACKING CODE	PACKING CODE	PACKAGE	PACKING
		SUFFIX <sup>(*)</sup>		
0405	A0		DO-201AD	500 / Ammo box
31DFx (Note 1)	R0	G	DO-201AD	1,250 / 13" Paper reel
(14010-1)	B0		DO-201AD	500 / Bulk packing

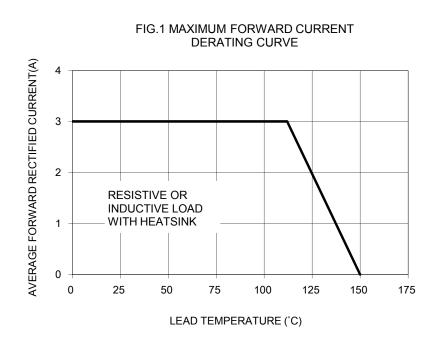
Note 1: "x" defines voltage from 400V (31DF4) to 600V (31DF6)

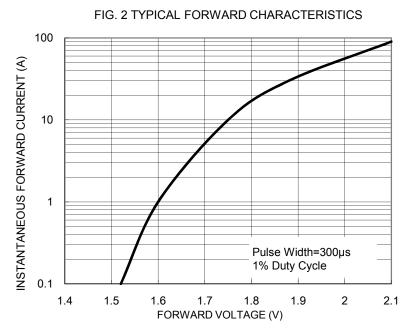
<sup>\*:</sup> Optional available

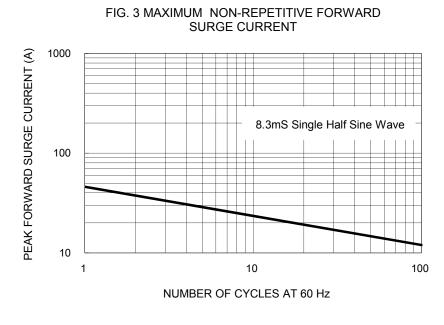
EXAMPLE				
PREFERRED P/N	PART NO.	PACKING CODE	PACKING CODE SUFFIX	DESCRIPTION
31DF4 A0G	31DF4	A0	G	Green compound

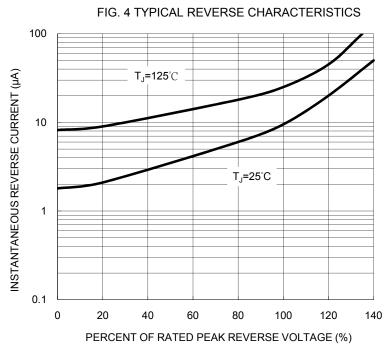
#### RATINGS AND CHARACTERISTICS CURVES

(T<sub>A</sub>=25°C unless otherwise noted)

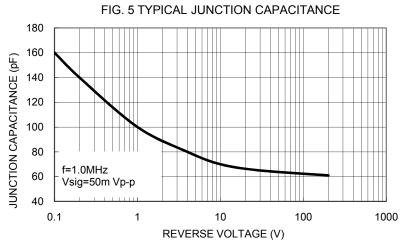




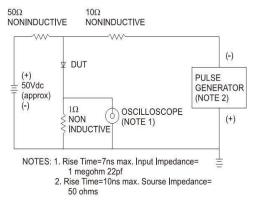


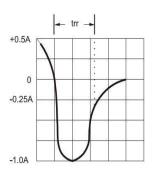






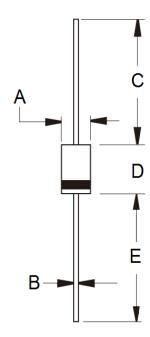
# FIG.6 REVERSE RECOVERY TIME CHARACTERISTIC AND TEST CIRCUIT DIAGRAM





# PACKAGE OUTLINE DIMENSIONS

# **DO-201AD**



DIM.	Unit (mm)		Unit (inch)		
DIIVI.	Min	Max	Min	Max	
Α	5.00	5.60	0.197	0.220	
В	1.20	1.30	0.048	0.052	
С	25.40	1	1.000	-	
D	8.50	9.50	0.335	0.375	
Е	25.40	-	1.000	-	

# MARKING DIAGRAM



P/N = Specific Device Code G = Green Compound

YWW = Date Code F = Factory Code





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